| L Number | Hits | Search Text | DB | Time stamp |
|---|---|---|---|---|
| 1 | 3 | ("5458912").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:25 |
| 8 | 679 | ("light-sensitive element" or "light$sensitive element") and data | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:37 |
| 15 | 45 | (("light-sensitive element" or "light$sensitive element") and data) and (coating same protective) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:30 |
| 22 | 0 | ((("light-sensitive element" or "light$sensitive element") and data) and (coating same protective)) and (filler same opaque) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:29 |
| 29 | 8 | (("light-sensitive element" or "light$sensitive element") and data) and (coating same filler) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:34 |
| 36 | 0 | (("5458912").PN.) and (semiconductor or "integrated circuit") | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:36 |
| 43 | 1251755 | (semiconductor or "integrated circuit") | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:37 |
| 50 | 168 | ( (semiconductor or "integrated circuit")) and ("light-sensitive element" or "light$sensitive element") and data | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:39 |
| 57 | 1 | ((( semiconductor or "integrated circuit")) and ("light-sensitive element" or "light$sensitive element") and data) and (filler same opaque) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:40 |
| 64 | 115 | ( (semiconductor or "integrated circuit")) and (filler same opaque) | USPAT; US-P PUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:41 |

| 71 | 1 | (( (semiconductor or "integrated circuit")) and (filler sam   opaque)) and smartcard | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:47 |
| 78 | 34 | (("light-sensitive element" or "light$sensitive element") and data) and IC | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 17:47 |

| L Number | Hits | Search Text | DB | Time stamp |
|---|---|---|---|---|
| 13 | 0 | ("428 and (coating or film)").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 08:22 |
| 20 | 1256 | 428/689 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 08:24 |
| 27 | 1044 | 428/689 and (coating or film) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 08:24 |
| 34 | 488 | (428/689 and (coating or film)) and (semiconductor or device) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 08:25 |
| 41 | 46 | ((428/689 and (coating or film)) and (semiconductor or device)) and opaque | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 08:25 |
| 48 | 12 | (((428/689 and (coating or film)) and (semiconductor or device)) and opaque) and filler | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/30 08:26 |